

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HUI-CHU HSIEH	04/30/2019
WEN-PIN HSIEH	04/30/2019
NIEN-JEN CHOU	04/30/2019
HUI-JU SHEN	04/30/2019
HUI-LING PENG	04/30/2019
JING-TSYR LIN	04/30/2019
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16398273
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<b>SIGNATURE:</b>	/Belinda Lee/
<b>DATE SIGNED:</b>	05/29/2019
<b>Total Attachments: 2</b>	

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## ASSIGNMENT

### WHEREAS,

1.Hui-Chu Hsieh  
3.Nien-Jen Chou  
5.Hui-Ling Peng

2.Wen-Pin Hsieh  
4.Hui-Ju Shen  
6.Jing-Tsyr Lin

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **BIOSENSOR AND BIOLOGICAL DETECTION METHOD**

Filed: Serial No.

Executed concurrently with the execution of this instrument

WHEREAS, 1. Industrial Technology Research Institute  
of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu  
31040, Taiwan, R. O. C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

## ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Hui-Chu Hsieh Date: 2019.04.30

Sole or First Joint Inventor: **Hui-Chu Hsieh**

Signature: WEN-PIN HSIEH Date: 4/30. 2019

Second Joint Inventor (if any): **Wen-Pin Hsieh**

Signature: Nien-Jen Chou Date: 2019.04.30

Third Joint Inventor (if any): **Nien-Jen Chou**

Signature: Hui-Ju Shen Date: 2019.04.30

Fourth Joint Inventor (if any): **Hui-Ju Shen**

Signature: Hui-Ling Peng Date: 2019.04.30

Fifth Joint Inventor (if any): **Hui-Ling Peng**

Signature: Jing-Tsy Lin Date: 2019.04.30

Sixth Joint Inventor (if any): **Jing-Tsy Lin**